

117TH CONGRESS
2D SESSION

H. R. 6359

To amend the William M. (Mac) Thornberry National Defense Authorization Act for Fiscal Year 2021 to improve the semiconductor incentive program of the Department of Commerce.

IN THE HOUSE OF REPRESENTATIVES

JANUARY 6, 2022

Ms. ESHOO (for herself and Mr. KELLY of Mississippi) introduced the following bill

JANUARY 10, 2022

Referred to the Committee on Energy and Commerce, and in addition to the Committee on Science, Space, and Technology, for a period to be subsequently determined by the Speaker, in each case for consideration of such provisions as fall within the jurisdiction of the committee concerned

A BILL

To amend the William M. (Mac) Thornberry National Defense Authorization Act for Fiscal Year 2021 to improve the semiconductor incentive program of the Department of Commerce.

1 *Be it enacted by the Senate and House of Representa-*
2 *tives of the United States of America in Congress assembled,*

3 **SECTION 1. SHORT TITLE.**

4 This Act may be cited as the “Investing in Domestic
5 Semiconductor Manufacturing Act”.

1 **SEC. 2. CLARIFICATION FOR UPSTREAM MANUFACTURERS.**

2 (a) DEFINITIONS.—Section 9901(2) of the William
3 M. (Mac) Thornberry National Defense Authorization Act
4 for Fiscal Year 2021 (15 U.S.C. 4651(2)) is amended—

5 (1) by inserting “production,” before “or re-
6 search and development”; and

7 (2) by striking “of semiconductors.” and insert-
8 ing “of semiconductors, materials used to manufac-
9 ture semiconductors, or semiconductor manufac-
10 turing equipment.”.

11 (b) SEMICONDUCTOR INCENTIVES.—Section 9902(a)
12 of the William M. (Mac) Thornberry National Defense Au-
13 thorization Act for Fiscal Year 2021 (15 U.S.C. 4652(a))
14 is amended—

15 (1) in paragraph (1)—

16 (A) by striking “for semiconductor fabrica-
17 tion” and inserting “for the fabrication”;

18 (B) by inserting “production,” before “or
19 research and development”; and

20 (C) by striking the period at the end and
21 inserting “of semiconductors, materials used to
22 manufacture semiconductors, or semiconductor
23 manufacturing equipment.”; and

1 (2) in paragraph (4)(A), by striking “used for
2 semiconductors” and inserting “used for the pur-
3 poses”.

○